Annular SH Series Thermoelectric Cooler

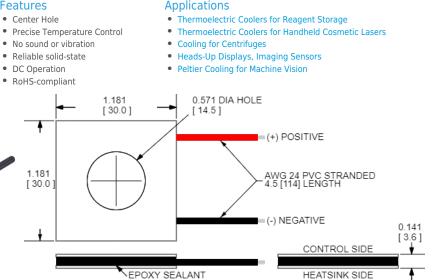
The SH10-95-06-L-EP-W4.5 is an annular-style thermoelectric cooler. The hot and cold side ceramics have a circular hole in the center to accommodate light protrusion for optics, mechanical fastening or temperature probe. It has a maximum Qc of 19.1 Watts when $\Delta T = 0$ and a maximum ΔT of 70.5 °C at Qc = 0.

Features

- Center Hole

- RoHS-compliant





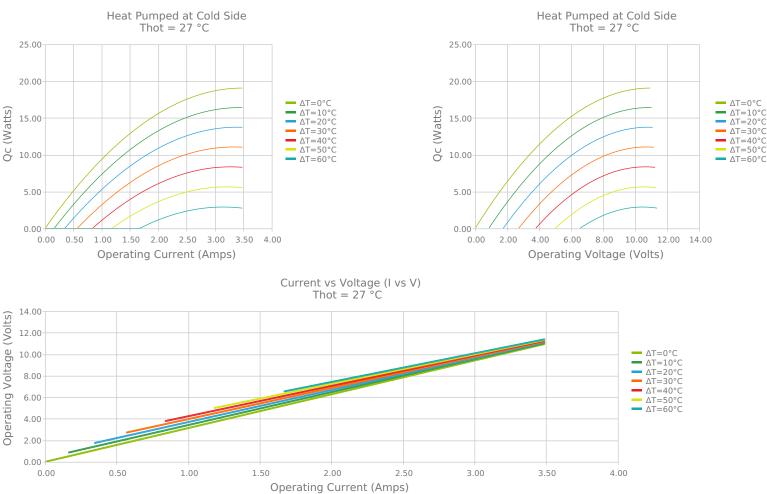
CERAMIC MATERIAL: Al2O3

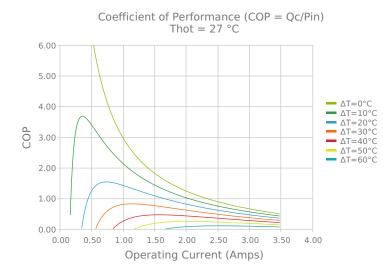
INCHES [MM]

SOLDER CONSTRUCTION: 138°C, BiSn Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

ELECTRICAL AND THERMAL PERFORMANCE

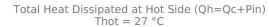
For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.

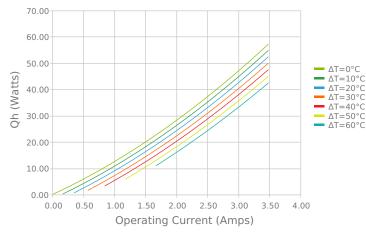


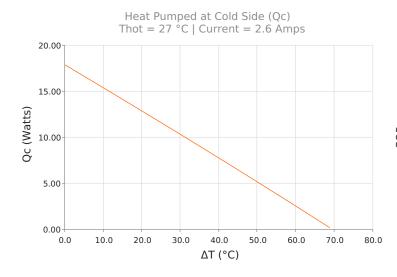


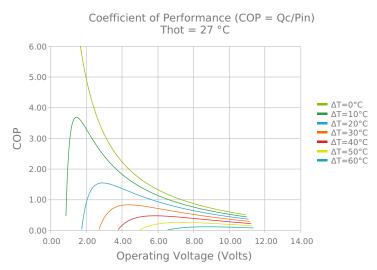
THERMAL

Laird





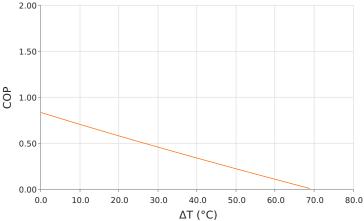




Total Heat Dissipated at Hot Side (Qh=Qc+Pin) Thot = 27 °C



Coefficient of Performance (COP = Qc/Pin) Thot = 27 °C | Current = 2.6 Amps



SPECIFICATIONS*

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
$Qcmax (\Delta T = 0)$	19.1 Watts	19.6 Watts	20.7 Watts
ΔTmax (Qc = 0)	70.5°C	73.5°C	78.8°C
lmax (I @ ΔTmax)	3.1 Amps	3.1 Amps	3.0 Amps
Vmax (V @ ΔTmax)	10.4 Volts	10.8 Volts	11.5 Volts
Module Resistance	3.14 Ohms	3.27 Ohms	3.51 Ohms
Max Operating Temperature	80 °C		
Weight	9.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L	3.581 ±0.254 mm 0.141 ± 0.0100 in	0.004 mm / 0.004 mm 0.00015 in / 0.00015 in	Lapped	Lapped	114.3 mm 4.50 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Ероху	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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Revision: 00 Date: 06-01-2022

Print Date: 06-13-2022